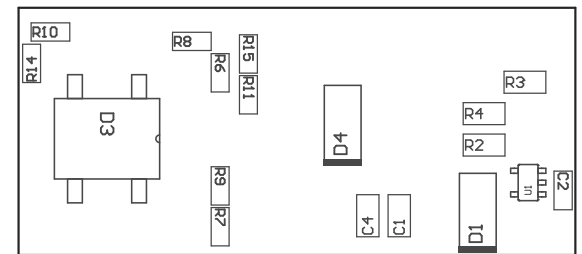


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP11236	REV: A	SVN REV: Not In VersionControl
	TID #:		
PLOT NAME = Top Assembly Drawing	GENERATED	: 8/3/2015 3:16:19 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP11236	REV: A	SVN REV: Not In VersionControl
	TID #:		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 8/3/2015 3:16:20 PM		TEXAS INSTRUMENTS

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